

ABSTRACT OF THE DISCLOSURE

A wafer grinder withholds a lateral force and adjusts a tilt of worktable with precision. The wafer grinder is used to grind a wafer; that is, the tilt angle of wafer can be adjusted so that wafer is ground with precision. The
5 wafer grinder has a housing module, a rotary worktable module, air pressure spindle module and an adjustment module.